



A Product Line of Diodes Incorporated



#### **100V PNP LED DRIVING TRANSISTOR IN SOT223**

#### Features

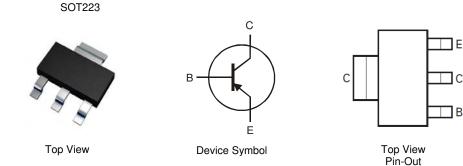
- BV<sub>CEO</sub> > -100V
- Maximum continuous current I<sub>C</sub> = -1A
- $h_{FE} > 100 @ I_C = -150mA, V_{CE} = -0.2V$
- Lead Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

#### Applications

LED TV backlight

#### Mechanical Data

- Case: SOT223
- Case material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish
- Weight: 0.112 grams (Approximate)



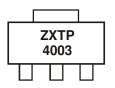
#### **Ordering Information**

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Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTP4003GTA	ZXTP4003	7	12	1,000

Notes: 1. No purposefully added lead.

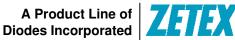
2. "Green" devices, Halogen and Antimony Free, Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com

#### **Marking Information**



ZXTP4003 = Product type Marking Code





#### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-100	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-100	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current	lc	-1	А
Peak Pulse Current (Note 4)	I <sub>CM</sub>	-3	А
Base Current	IB	-500	mA

### Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	PD	2	W
Thermal Resistance, Junction to Ambient (Note 3)	R <sub>0JA</sub>	62.5	°C/W
Thermal Resistance, Junction to Leads (Note 5)	R <sub>0JL</sub>	28.75	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

3. For a device surface mounted on 25mm X 25mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions Notes:

4. Measured under pulsed conditions. Pulse width = 300µs. Duty cycle ≤ 2%.

5. Thermal resistance from junction to solder-point (on the exposed collector pad).

## Thermal Characteristics and Derating Information

100m

1

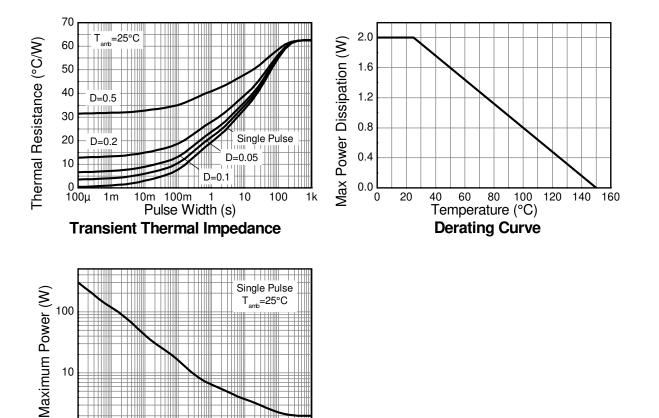
Pulse Width (s) **Pulse Power Dissipation** 

10

100

1k

10m



100µ

1m



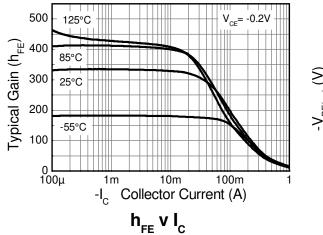


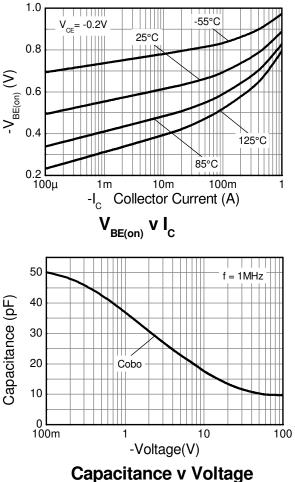
# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
Collector-Emitter Breakdown Voltage (Note 6)	BV <sub>CEO</sub>	-100	-170	-	V	I <sub>C</sub> = -10mA	
Collector Cut-off Current	ICBO	-	-	-50	nA	V <sub>CB</sub> = -100V	
Emitter Cut-off Current	I <sub>EBO</sub>	-	-	-50	nA	V <sub>EB</sub> = -7V	
Static Forward Current Transfer Ratio (Note 6)	h <sub>FE</sub>	60 100	133 112	-	-	$I_{C} = -85mA, V_{CE} = -0.15V$ $I_{C} = -150mA, V_{CE} = -0.2V$	
Base-Emitter Turn-On Voltage (Note 6)	V <sub>BE(on)</sub>	-	-0.71	-0.95	V	I <sub>C</sub> = -150mA, V <sub>CE</sub> = -0.2V	
Delay Time	t <sub>(d)</sub>	-	378	-	ns		
Rise Time	t <sub>(r)</sub>	-	388	-	ns	$V_{CC} = -80V, I_C = -150mA,$ $-I_{B2} = 1.5mA, V_{CE(ON)} = -0.2V$	
Storage Time	t <sub>(s)</sub>	-	1348	-	ns		
Fall Time	t <sub>(f)</sub>	-	382	-	ns		
Storage Time	t <sub>(s)</sub>	-	75	-	ns	V <sub>CC</sub> = -80V, I <sub>C</sub> = -150mA,	
Fall Time	t <sub>(f)</sub>	-	363	-	ns	$-I_{B2} = 1.5 \text{mA}, V_{CE(ON)} = -4 \text{V}$	

Notes: 6. Measured under pulsed conditions. Pulse width =  $300\mu$ s. Duty cycle  $\leq 2\%$ 

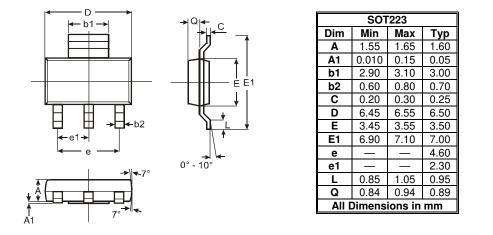
Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified



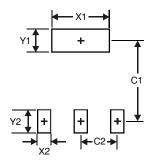




## **Package Outline Dimensions**



## **Suggested Pad Layout**



Dimensions	Value (in mm)
X1	3.3
X2	1.2
Y1	1.6
Y2	1.6
C1	6.4
C2	2.3



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